

RELIABILITY REPORT FOR MAX2209EBS+ CHIP SCALE PACKAGE

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MAXIM INTEGRATED PRODUCTS

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Conclusion

The MAX2209EBS+ successfully meets the quality and reliability standards required of all Maxim products. In addition, Maxim's continuous reliability monitoring program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards.

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I. Device Description

A. General

The MAX2209 is a wideband (800MHz to 2GHz) RF power detector. It takes an RF signal from the directional coupler at the input, and outputs a DC voltage proportional to the RF peak voltage. The change in output voltage versus temperature is very repeatable from part to part and enables a lookup table based on nominal behavior, minimizing the effective detection error to less than ±0.5dB relative to room temperature. The MAX2209 comes in a space-saving 2 x 2, 0.5mm pitch wafer-level package (WLP) and requires only two external components.



II. Manufacturing Information

A. Description/Function:	Industry's Smallest Power-Detection Circuit
B. Process:	GST2
C. Number of Device Transistors:	293
D. Fabrication Location:	Oregon
E. Assembly Location:	Dallas, Texas
F. Date of Initial Production:	February 2, 2010

III. Packaging Information

A. Package Type:	4-pin UCSP
B. Lead Frame:	N/A
C. Lead Finish:	N/A
D. Die Attach:	N/A
E. Bondwire:	N/A
F. Mold Material:	N/A
G. Assembly Diagram:	# 05-9000-3895
H. Flammability Rating:	Class UL94-V0
H. Flammability Rating:I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C	Class UL94-V0 Level 1
I. Classification of Moisture Sensitivity per	
I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-C	Level 1
I. Classification of Moisture Sensitivity per JEDEC standard J-STD-020-CJ. Single Layer Theta Ja:	Level 1

IV. Die Information

A. Dimensions:	40.16 X 40.16 mils
B. Passivation:	Si ₃ N ₄ (Silicon nitride)
C. Interconnect:	Au
D. Backside Metallization:	None
E. Minimum Metal Width:	2 microns (as drawn)
F. Minimum Metal Spacing:	2 microns (as drawn)
G. Bondpad Dimensions:	5 mil. Sq.
H. Isolation Dielectric:	SiO ₂
I. Die Separation Method:	Wafer Saw



A. Quality Assurance Contacts:	Don Lipps (Manager, Reliability Engineering) Bryan Preeshl (Managing Director of QA)
B. Outgoing Inspection Level:	0.1% for all electrical parameters guaranteed by the Datasheet. 0.1% For all Visual Defects.
C. Observed Outgoing Defect Rate:	< 50 ppm
D. Sampling Plan:	Mil-Std-105D

VI. Reliability Evaluation

A. Accelerated Life Test

The results of the 150°C biased (static) life test are shown in Table 1. Using these results, the Failure Rate (λ) is calculated as follows:

 $\lambda = \underbrace{1}_{\text{MTTF}} = \underbrace{1.83}_{192 \text{ x} 4340 \text{ x} 48 \text{ x} 2} \text{ (Chi square value for MTTF upper limit)}$ $\chi = 22.9 \text{ x} 10^{-9}$

λ = 22.9 F.I.T. (60% confidence level @ 25°C)

The following failure rate represents data collected from Maxim's reliability monitor program. Maxim performs quarterly life test monitors on its processes. This data is published in the Reliability Report found at http://www.maxim-ic.com/qa/reliability/monitor. Cumulative monitor data for the GST2 Process results in a FIT Rate of 0.06 @ 25C and 1.10 @ 55C (0.8 eV, 60% UCL)

B. E.S.D. and Latch-Up Testing (lot NB3ZAQ001A, D/C 0934)

The WC24 die type has been found to have all pins able to withstand a HBM transient pulse of +/-2500V per JEDEC JESD22-A114. Latch-Up testing has shown that this device withstands a current of +/-250mA.



Table 1 Reliability Evaluation Test Results

MAX2209EBS+

TEST ITEM	TEST CONDITION	FAILURE IDENTIFICATION	SAMPLE SIZE	NUMBER OF FAILURES	COMMENTS
Static Life Test (N	lote 1) Ta = 135°C Biased Time = 192 hrs.	DC Parameters	48	0	NB3ZAQ001A, D/C 0934

Note 1: Life Test Data may represent plastic DIP qualification lots.